

## **Not Recommended for New Designs**

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This product was manufactured for Maxim by an outside wafer foundry using a process that is no longer available. It is not recommended for new designs. The data sheet remains available for existing users.

A Maxim replacement or an industry second-source may be available. Please see the QuickView data sheet for this part or contact technical support for assistance.

For further information, [contact Maxim's Applications Tech Support](#).

**SCOPE: PIN-PROGRAMMABLE PRECISION VOLT REFERENCE**

<u>Device Type</u>	<u>Generic Number</u>
01	MX584S(x)/883B
02	MX584T(x)/883B

**Case Outline(s).** The case outlines shall be designated in Mil-Std-1835 and as follows:

<u>Outline Letter</u>	<u>Mil-Std-1835</u>	<u>Case Outline</u>	<u>Package Code</u>
H	MACY1-X3	8 Lead TO-99 Can	G99
Q	GDIP1-T8 or CDIP2-T8	8 Lead CERDIP	J8

**Absolute Maximum Ratings**

Input Voltage to GND .....	40V
Lead Temperature (soldering, 10 seconds).....	+300°C
Storage Temperature.....	-65°C to +150°C
Continuous Power Dissipation..... $T_A=+70^\circ\text{C}$	
8-Pin TO-99 Can(derate 6.1mW/°C above +70 °C).....	.533mW
8-Pin CERDIP(derate 8.0mW/°C above +70 °C).....	.640mW
Junction Temperature $T_J$ .....	+150 °C
Thermal Resistance, Junction to Case, $\Theta_{JC}$ :	
8-Pin TO-99 Can .....	45 °C/W
8-Pin CERDIP.....	55 °C/W
Thermal Resistance, Junction to Ambient, $\Theta_{JA}$ :	
8-Pin TO-99 Can .....	150 °C/W
8-Pin CERDIP.....	125 °C/W

**Recommended Operating Conditions**

Supply Voltage Range ( $V_{IN}$ ).....	4.5V min to 30V max
Ambient Operating Range ( $T_A$ ).....	-55 °C to +125 °C

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 1 ELECTRICAL TESTS

TEST	Symbol	CONDITIONS -55 °C ≤ T <sub>A</sub> ≤ +125 °C V <sub>CC</sub> =+15V, I <sub>L</sub> =0mA Unless otherwise specified	Group A Subgroup	Device Type	Limits Min	Limits Max	Units
Quiescent Current	I <sub>Q</sub>		1	All		1.0	mA
Output Voltage Error	V <sub>OUT1</sub>	10V Output	1	01 02	-30 -10	+30 +10	mV
	V <sub>OUT2</sub>	7.5V Output	1	01 02	-22 -8	+22 +8	
	V <sub>OUT3</sub>	5.0V Output	1	01 02	-15 -6	+15 +6	
	V <sub>OUT4</sub>	2.5V Output	1	01 02	-7.5 -3.5	+7.5 +3.5	
Line Regulation  NOTE 1	VR <sub>LINE1</sub>	V <sub>OUT</sub> =2.5V, 5V, 7.5V, 10V; (V <sub>OUT</sub> +2.5V) ≤ V <sub>CC</sub> < 15V	1 2,3	All		.005 .010	±%/V
	VR <sub>LINE2</sub>	V <sub>OUT</sub> =2.5V, 5V, 7.5V, 10V; 15V ≤ V <sub>CC</sub> < 30V	1 2,3		.002 .005		
Load Regulation	VR <sub>LOAD</sub> 1, 2, 3, 4	I <sub>L</sub> =0mA to 5mA, Output = 10V, 7.5V, 5V, 2.5V	1 2,3	All		+50 +100	±ppm/mA
Output Short Circuit Current	I <sub>OS</sub>	10V output grounded	1	All		55	mA
Output Voltage Temperature Coefficient	ΔV <sub>OUT1</sub> /ΔT	10V Output	2,3	01 02		+30 +15	±ppm/°C
	ΔV <sub>OUT2</sub> /ΔT	7.5V Output	2,3	01 02		+30 +15	
	ΔV <sub>OUT3</sub> /ΔT	5.0V Output	2,3	01 02		+30 +15	
	ΔV <sub>OUT4</sub> /ΔT	2.5V Output	2,3	01 02		+30 +20	
Output Current NOTE 2	I <sub>OUT</sub>	Source	1 2,3	All	10 5		mA
		Sink	1 2,3		200		μA

NOTE 1: 10V output for Subgroup 2 and 3.

NOTE 2: For applications that require the MX584 to sink current, maintain a load capacitance of 10nF.

PIN CONFIGURATION

PIN	J8/G99	
1	10.0V	NC
2	5.0V	10.0V
3	2.5V	NC
4	GND	NC
5	STROBE	5.0V
6	V <sub>BG</sub>	NC
7	CAP	2.5V
8	V <sub>CC</sub>	NC

ORDERING INFORMATION	
Device	Maxim Part Number
01	MX584SH/883B
02	MX584TH/883B

## QUALITY ASSURANCE

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

1. Test Condition, A, B, C, or D.
2.  $T_A = +125^\circ\text{C}$  minimum.
3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

1. Tests as specified in Table 2.
2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

- a. End-point electrical parameters shall be specified in Table 1.
- b. Steady-state life test, Method 1005 of Mil-Std-883:
  1. Test condition A, B, C, D.
  2.  $T_A = +125^\circ\text{C}$  minimum.
  3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

**TABLE 2. ELECTRICAL TEST REQUIREMENTS**

Mil-Std-883 Test Requirements	Subgroups per Method 5005, Table 1
Interim Electrical Parameters Method 5004	1
Final Electrical Parameters Method 5005	1*, 2, 3
Group A Test Requirements Method 5005	1, 2, 3
Group C and D End-Point Electrical Parameters Method 5005	1

\* PDA applies to Subgroup 1 only.